

JIANGSU CHANGJIANG ELECTRONICS TECHNOLOGY CO., LTD

T0-220H-3L Plastic-Encapsulate MOSFETS

CJP71N90

N-Channel MOSFET

DESCRIPTION

The CJP71N90 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge .This device is suitable for use in a wide variety of applications.

FEATURES

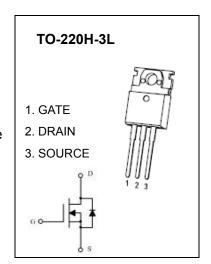
- Lead free product is acquired
- Special process technology for high ESD capability
- High density cell design for ultra low R_{DS(on)}
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

APPLICATION

- Power switching application
- Hard switching and high frequency circuits
- Uninterruptible power supply

Maximum ratings (T_a=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	71	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current	I _D	90	Α
Pulsed Drain Current (note 1)	I _{DM}	320	Α
Thermal Resistance from Junction to Ambient (note 2)	R _{θJA}	62.5	°C/W
Single Pulsed Avalanche Energy (note5)	E _{AS}	580	mJ
Junction Temperature	TJ	150	°C
Storage Temperature	T _{STG}	-55~+150	°C



Electrical characteristics (T_a=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
STATIC CHARACTERISTICS								
Drain-source breakdown voltage	V (BR)DSS	V _{GS} = 0V, I _D =250µA	71			V		
Zero gate voltage drain current	IDSS	V _{DS} =71V,V _{GS} = 0V			1	μΑ		
Gate-body leakage current	Igss	V _{GS} =±20V, V _{DS} = 0V			±100	nA		
Gate threshold voltage (note 3)	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2		4	V		
Drain-source on-resistance (note 3)	RDS(on)	V _{GS} =10V, I _D =40A			ΪĚ	mΩ		
Forward transconductance (note 3)	grs	V _{DS} =5V, I _D =40A		60		S		
Diode forward voltage (note 3)	V_{SD}	I _S =20A, V _{GS} = 0V			1.2	V		
DYNAMIC CHARACTERISTICS (note 4)								
Input capacitance	C _{iss}			4871		pF		
Output capacitance	Coss	V _{DS} =15V,V _{GS} =0V,f =1MHz		630.6		pF		
Reverse transfer capacitance	C _{rss}			410.3		pF		
Gate resistance	Rg	V _{DS} =0V,V _{GS} =0V,f =1MHz		0.63		Ω		
SWITCHING CHARACTERISTICS (note	4)							
Turn-on delay time	td(on)			36.1		ns		
Turn-on rise time	tr	V _{GS} =10V,V _{DS} =30V,		54.3		ns		
Turn-off delay time	td(off)	R _{GEN} =10Ω, I _D =42A		85.2		ns		
Turn-off fall time	t f			37.3		ns		
Total gate charge	Q_g			85.7		nC		
Gate-source Charge	Q _{gs}	V _{DS} =48V,V _{GS} =10V,I _D =84A		23.2		nC		
Gate-drain Charge	Q_{gd}			31.2		nC		
Body diode reverse recovery time	4			88.3		ns		
(note 3)	t _{rr}	- I₅=84A.dl/dt=100A/µs		00.3				
Body diode reverse recovery charge	Q _{rr}	1;0+Λ,αι/αι-100 <i>Ρ</i> /μ5		65.9		nC		
(note 3)	∀ ſſ			00.9				

Notes:

- 1. Repetitive rating : Pulse width limited by junction temperature.
- 2. Surface mounted on FR4 board , t≤10s.
- 3. Pulse Test : Pulse Width≤300µs, Duty Cycle≤2%.
- 4. Guaranteed by design, not subject to producting.
- 5 L=0.5mH, V_{DD} =37.5V, V_{GS} =10V, R_G =25 Ω , Starting T_J =25 $^{\circ}$ C .